DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

METHODS AND COMPOSITIONS FOR TREATING HYPERLIPEMIA

the specific	cation of which	
(check one)	[X] is attached hereto	
	[] was filed on Application Serial No.	
	was amended on	
		(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I do not know and do not believe that the invention was ever patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to this application.

I do not know and do not believe that the invention was in public use or on sale in the United States of America more than one year prior to this application.

I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known by me to be material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim priority benefits under Title 35, United States Code, § 119(a) of any foreign application(s) for patent or inventor's certificate listed below and under Title 35, United States Code, § 119(e) of any provisional applications filed under 35 U.S.C. § 111(b) listed below and have also identified below any foreign application for patent, inventor's certificate or provisional application having a filing date before that of the application on which priority is claimed:

Prior Foreign or Provis	sional Application(s	c)	
3		,	Priority Claimed
(Number)	(Country)	(Day/Month/Year Filed)	[] [] Yes No
(Number)	(Country)	(Day/Month/Year Filed)	[] [] Yes No
		,	
application(s) listed be application is not discl by the first paragraph of disclose to the United to be material to patent	elow and, insofar as osed in the prior Ur of Title 35, United States Patent and Trability as defined in the between the filing	United States Code, § 120 of the subject matter of each of nited States application in the States Code, § 112, I acknow rademark Office all informat in Title 37, Code of Federal R g date of the prior application olication:	the claims of this manner provided ledge the duty to ion known by me legulations, § 1.56
(Appln. Serial No.)	(Filing Date	(Status)(pa Pending, a	
(Appln. Serial No.)	(Filing Date	(Status)(pa Pending, a	
		following attorneys or agent United States Patent and Tra	
	James F. Ha	lley, Jr., Esq. (Reg. No. 27,79	94)
		Esq. (Reg. No. 42,800)	
		, Esq. (Reg. No. 48,290)	
		(Reg. No. 51,303)	
		No. 45,141)	
	Haitao Sun	(Reg. No. 48,546)	
Send correspondence t	o· Iames F. Ha	ıley, Jr., Esq.	
oma con coponacino .	c/o FISH & NE		
	· · · · · · · · · · · · · · · · · · ·	e of the Americas	
		New York 10020-1104	
Direct telephone calls	to: James F. Ha	lley, Jr., Esq.	
	212.596.900		

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole inve	entor Ling Y. Cheung	
Sole Inventor's signat	ure	
- 3	Date	
Residence Flat 11A	A, Tower 2, Deerhill Bay, Taipo, New Territories, Hong Kon	ıg
Citizenship	People's Republic of China	
Post Office Address	2 Dai Fu Street, Tai Po Industrial Estate, N.T., Hong Kong	Ţ